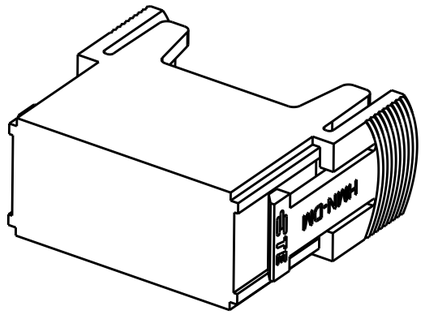
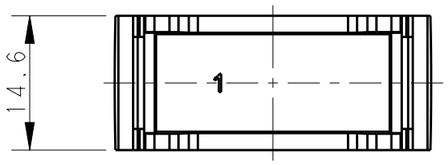
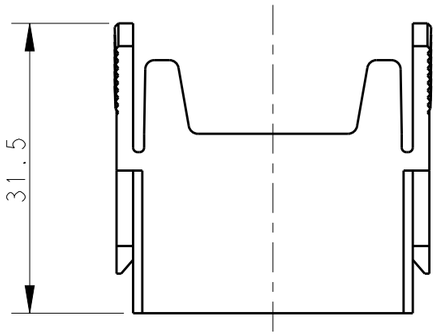
THIS DRAWING IS UNPUBLISHED. RELEASED FOR PUBLICATION 20
© COPYRIGHT 20 BY - ALL RIGHTS RESERVED.

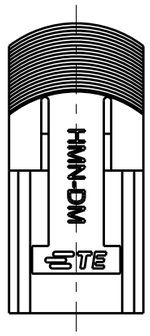
REVISIONS

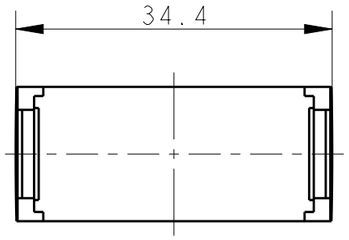
| P | LTR | DESCRIPTION | DATE | DWN | APVD |
|---|---|---|---|---|---|
| | A | INITIAL | 19SEP2017 | YC | CW |
| | | | | | |
| | | | | | |
| | | | | | |




NOTES:
1. TECHNICAL CHARACTERISTICS:
   INSULATION MATERIAL: PC
   BLIND MODULE

注释：
1. 技术参数：
   绝缘材料： PC
   空白模块

| | | |
|---|---|---|
| T3110009902-007 | HMN-DM | HMN-DM BLIND MODULE FRAME<br>HMN-DM 模块框架堵头 |
| PART NUMBER<br>料 号 | | PART DESCRIPTION<br>描 述 |

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm

TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC ±-
1 PLC ±-
2 PLC ±-
3 PLC ±-
4 PLC ±-
ANGLES ±-

MATERIAL -
-

FINISH -
-

DWN YORK CHEN 19SEP2017
CHK GINO YAO 19SEP2017
APVD CHRIS WANG 19SEP2017
PRODUCT SPEC -
APPLICATION SPEC -
WEIGHT -

TE Connectivity

NAME HMN-DM

| SIZE | CAGE CODE | DRAWING NO | RESTRICTED TO |
|---|---|---|---|
| A3 | 00779 | C-T3110009902007 | - |

Customer Drawing | SCALE 3:2 | SHEET 1 OF 1 | REV A

1470-19 (3/13)

Downloaded from Arrow.com.